

CBR04C849B3GAC

CBR-SMD RF COG, Ceramic, 8.4 pF, +/-0.1 pF, 25 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



Click here for the 3D model.

| Dimensions | |
|------------|---------------------|
| Chip Size | 0402 |
| L | 1mm +/-0.05mm |
| W | 0.5mm +/-0.05mm |
| Т | 0.5mm +/-0.05mm |
| В | 0.25mm +0.05/-0.1mm |

| Packaging Specifications | |
|--------------------------|--------------------------|
| Packaging | T&R, 180mm, Plastic Tape |
| Packaging Quantity | 10000 |

| General Information | |
|---------------------|--|
| Series | CBR-SMD RF COG |
| Style | SMD Chip |
| Description | SMD, Fixed, RF, Ultra High Q, Low ESR, Class I |
| Features | Ultra High Q, Low ESR, Class I |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Component Weight | 1.4 mg |
| Notes | Solder Reflow Only. |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| 8.4 pF |
|---------------------|
| +/-0.1pF |
| 25 VDC |
| 62.5 VDC |
| -55/+125°C |
| COG |
| 0.176% |
| 0% Loss/Decade Hour |
| 10 GOhms |
| 568 |
| |

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